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SEMICONDUCTOR®

## **FDMS7660** N-Channel PowerTrench<sup>®</sup> MOSFET 30 V, 2.8 m $\Omega$

#### Features

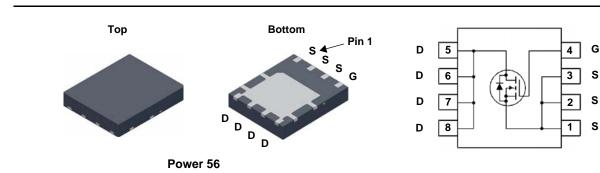
- Max  $r_{DS(on)}$  = 2.8 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 25 A
- Max  $r_{DS(on)}$  = 3.5 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 19 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery. Provides Schottky-like performance with minimum EMI in sync buck converter applications
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

## **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed and body diode reverse recovery performance.

### **Applications**

- IMVP Vcore Switching for Notebook
- VRM Vcore Switching for Desktop and Server
- OringFET / Load Switch
- DC-DC Conversion



### **MOSFET Maximum Ratings** $T_A = 25 \degree C$ unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		42		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		144		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	25	Α	
	-Pulsed			150		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	128	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		78	w	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Ra	ange		-55 to +150	°C	
Thermal Ch	naracteristics					
$R_{\theta JC}$	Thermal Resistance, Junction to Case			1.6	°C/M	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient		(Note 1a)	50	°C/W	

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7660	FDMS7660	Power 56	13 "	12 mm	3000 units

April 2009

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	30			V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		17		mV/°0
DSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
On Chara	octeristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.25	1.9	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-7		mV/°0
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V , I <sub>D</sub> = 25 A		1.9	2.8	
	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 19 \text{ A}$		2.7	3.5	mΩ
- \ - /		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 25 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		2.5	3.7	1
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 25 A		250		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			4185	5565	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		1380	1830	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	_f = 1 MHz		125	190	pF
- 133				-		1
×	Gate Resistance			0.9	2.0	Ω
Switching t <sub>d(on)</sub>	g Characteristics Turn-On Delay Time			17	31	ns
<b>Switching</b> t <sub>d(on)</sub> t <sub>r</sub>	g Characteristics Turn-On Delay Time Rise Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 25\text{ A},$		17 9	31 18	ns ns
Switching t <sub>d(on)</sub> t <sub>r</sub>	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 25\text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$		17 9 37	31 18 60	ns ns ns
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time	$V_{GS} = 10 \text{ V},  \overline{\text{R}}_{\text{GEN}} = 6 \Omega$		17 9 37 7	31 18 60 13	ns ns ns ns
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge	$V_{GS} = 10 \text{ V},        $		17 9 37 7 60	31 18 60 13 84	ns ns ns nc
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$		17 9 37 7 60 27	31 18 60 13	ns ns ns nC nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_g$ $Q_{gs}$	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{GS} = 10 \text{ V},  \text{R}_{\text{GEN}} = 6 \Omega$ $V_{\text{GS}} = 0 \text{ V to } 10 \text{ V}$		17 9 37 7 60 27 12.3	31 18 60 13 84	ns ns ns nC nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_g$ $Q_{gs}$ $Q_{gd}$	g CharacteristicsTurn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate ChargeGate to Source ChargeGate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$		17 9 37 7 60 27	31 18 60 13 84	ns ns ns nC nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_g$ $Q_{gs}$ $Q_{gd}$	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{GS} = 10 \text{ V},        $		17 9 37 7 60 27 12.3 7.2	31 18 60 13 84 38	ns ns ns nC nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_g$ $Q_{gs}$ $Q_{gd}$	g CharacteristicsTurn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate ChargeGate to Source ChargeGate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V},        $		17 9 37 7 60 27 12.3	31 18 60 13 84	ns ns ns nC nC
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_{gs}$ $Q_{gg}$ $Q_{gd}$ Drain-Sou $V_{SD}$	g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge urce Diode Characteristics	$V_{GS} = 10 \text{ V},        $		17 9 37 7 60 27 12.3 7.2	31 18 60 13 84 38 0.95	ns ns ns nC nC nC
Switching t <sub>d(on)</sub> t <sub>r</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> Drain-Sou V <sub>SD</sub> t <sub>rr</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage	$V_{GS} = 10 \text{ V},        $		17 9 37 7 60 27 12.3 7.2 0.7 0.8	31 18 60 13 84 38 0.95 1.1	ns ns ns nC nC nC nC v
Switching t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gd</sub> Drain-Sou V <sub>SD</sub> t <sub>rr</sub>	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage         Reverse Recovery Time	$V_{GS} = 10 \text{ V},        $		17 9 37 7 60 27 12.3 7.2 0.7 0.8 46	31 18 60 13 84 38 0.95 1.1 74	ns ns ns nC nC nC nC v
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_{g}$ $Q_{g}$ $Q_{g}$ $Q_{gd}$ Drain-Sou $V_{SD}$ $t_{rr}$ $Q_{rr}$ $t_a$	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage         Reverse Recovery Time         Reverse Recovery Charge	$V_{GS} = 10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V},$ $I_D = 25 \text{ A}$ $V_{GS} = 0 \text{ V}, \ I_S = 2.1 \text{ A}  (\text{Note } 2)$ $V_{GS} = 0 \text{ V}, \ I_S = 25 \text{ A}  (\text{Note } 2)$		17 9 37 7 60 27 12.3 7.2 0.7 0.8 46 26	31 18 60 13 84 38 0.95 1.1 74	ns ns nC nC nC nC v v
Switching $t_{d(on)}$ $t_r$ $t_q$ $Q_g$ $Q_g$ $Q_{gd}$ Drain-Sou $V_{SD}$ $t_{rr}$ $Q_{rr}$ $t_a$ $t_a$ $t_b$	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage         Reverse Recovery Time         Reverse Recovery Fall Time	$V_{GS} = 10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V},$ $I_D = 25 \text{ A}$ $V_{GS} = 0 \text{ V}, \ I_S = 2.1 \text{ A}  (\text{Note } 2)$ $V_{GS} = 0 \text{ V}, \ I_S = 25 \text{ A}  (\text{Note } 2)$		17 9 37 7 60 27 12.3 7.2 0.7 0.8 46 26 19	31 18 60 13 84 38 0.95 1.1 74	ns ns nC nC nC nC v v
Switching $t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $Q_g$ $Q_g$ $Q_{gs}$ $Q_{gd}$ Drain-Sou	g Characteristics         Turn-On Delay Time         Rise Time         Turn-Off Delay Time         Fall Time         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         urce Diode Characteristics         Source to Drain Diode Forward Voltage         Reverse Recovery Time         Reverse Recovery Fall Time         Reverse Recovery Rise Time	$V_{GS} = 10 \text{ V}, \ \overline{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $I_D = 15 \text{ V},$ $I_D = 25 \text{ A}$ $V_{GS} = 0 \text{ V}, \ I_S = 2.1 \text{ A}  (\text{Note } 2)$ $V_{GS} = 0 \text{ V}, \ I_S = 25 \text{ A}  (\text{Note } 2)$		17 9 37 7 60 27 12.3 7.2 0.7 0.8 46 26 19 27	31 18 60 13 84 38 0.95 1.1 74	ns ns nC nC nC nC v v



2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

3.  $E_{AS}$  of 128 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 16 A,  $V_{DD}$  = 27 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 23 A.

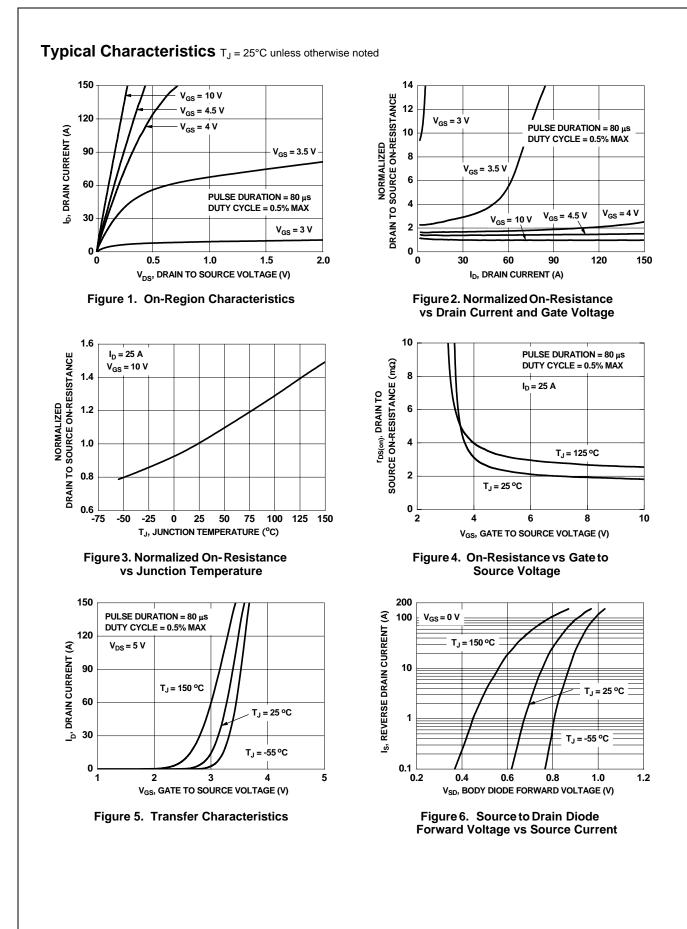
As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.
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 FDMS7660 Rev. D
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a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

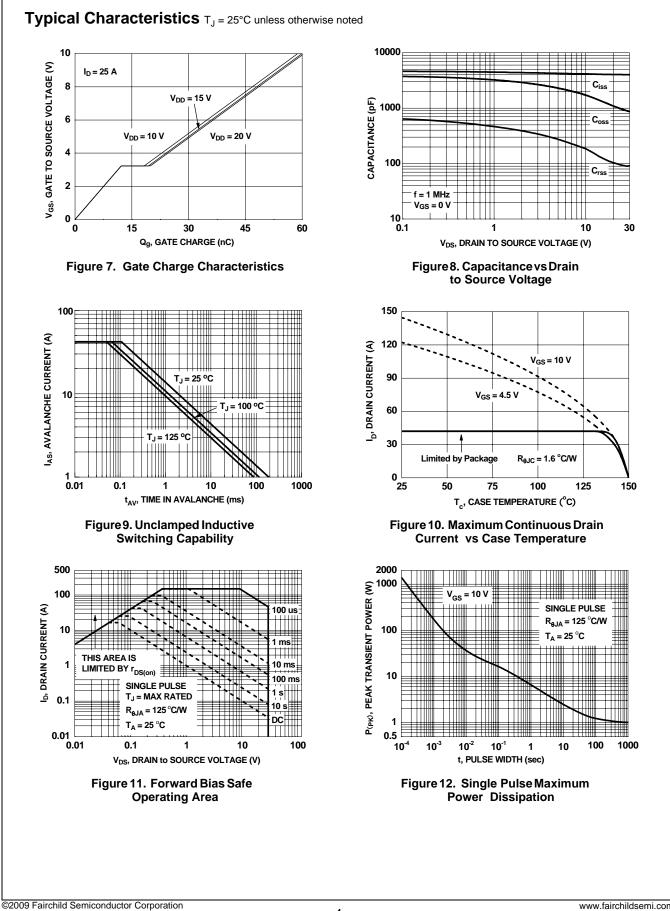
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b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

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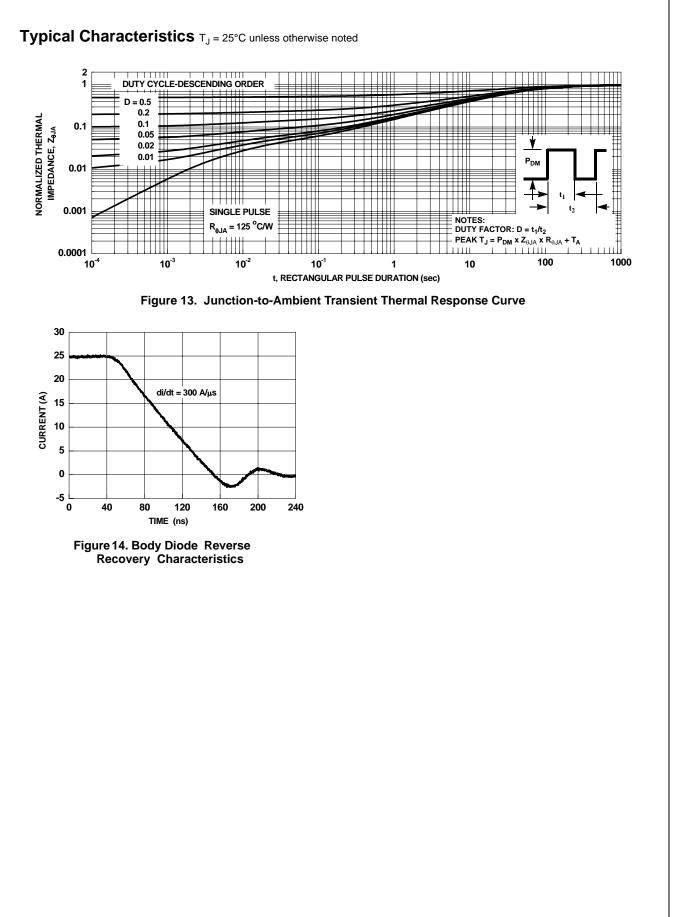


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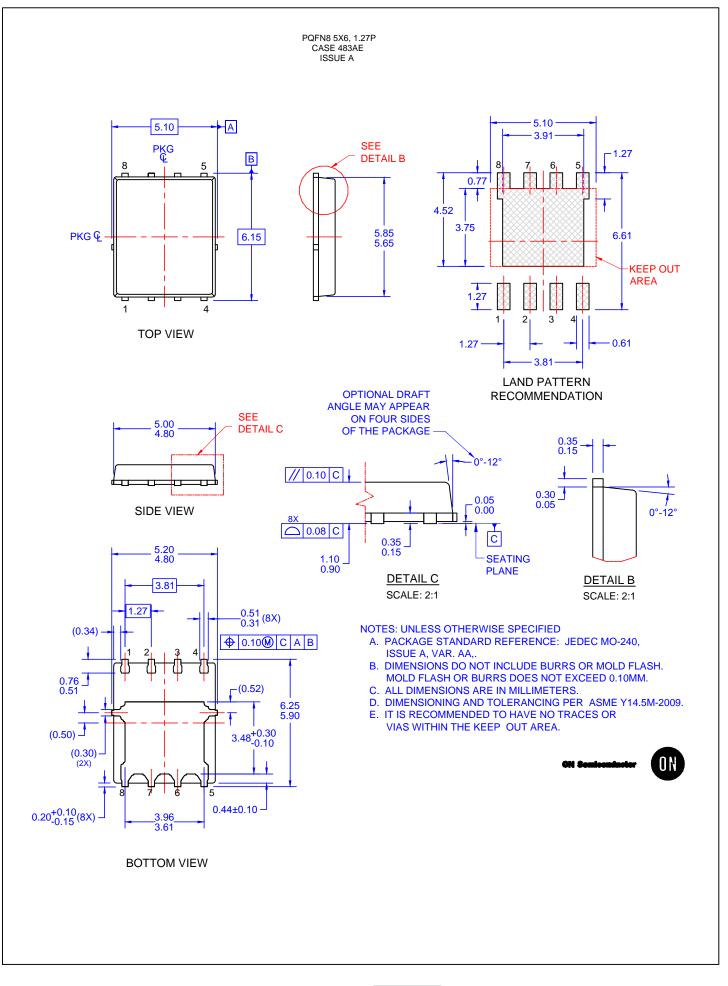


FDMS7660 Rev. D

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FDMS7660 N-Channel PowerTrench® MOSFET



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